10/594322
IAP5 Rec'd PCT/PTO 27 SEP 2006

DOCKET NO: 295408US40PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :

DAISUKE HIROKANE : ATTN: APPLICATION DIVISION

SERIAL NO: NEW U.S. PCT APPLICATION :
(BASED ON PCT/JP05/04705)

FILED: HEREWITH :

FOR: EPOXY RESIN COMPOSITION FOR THE ENCAPSULATION OF SEMICONDUCTORS AND SEMICONDUCTOR DEVICES :

PRELIMINARY AMENDMENT

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 4 of this paper.